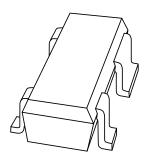
DISCRETE SEMICONDUCTORS

DATA SHEET



BGA2001Silicon MMIC amplifier

Product specification Supersedes data of 1999 Jul 23



Silicon MMIC amplifier

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FEATURES

- Low current, low voltage
- · Very high power gain
- · Low noise figure
- Integrated temperature compensated biasing
- Supply and RF output pin combined.

APPLICATIONS

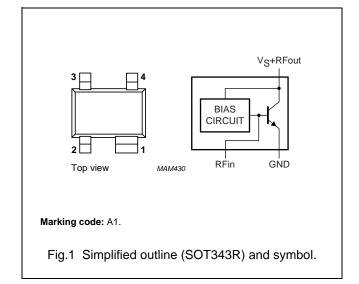
- · RF front end
- Wideband applications, e.g. analog and digital cellular telephones, cordless telephones (PHS, DECT, etc.)
- · Radar detectors
- · Low noise amplifiers
- Satellite television tuners (SATV)
- High frequency oscillators.

DESCRIPTION

Silicon MMIC amplifier consisting of an NPN double polysilicon transistor with integrated biasing for low voltage applications in a plastic, 4-pin dual-emitter SOT343R package.

PINNING

PIN	DESCRIPTION	
1	GND	
2	RF in	
3	GND	
4	V _S + RFout	



QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
Vs	DC supply voltage	RF input AC coupled	_	4.5	V
I _S	DC supply current	V _{VS-OUT} = 2.5 V; RF input AC coupled	4.5	-	mA
MSG	maximum stable gain	$V_{VS-OUT} = 2.5 \text{ V}; f = 1.8 \text{ GHz};$ $T_{amb} = 25 ^{\circ}\text{C}$	19.5	_	dB
NF	noise figure	V_{VS-OUT} = 2.5 V; f = 1.8 GHz; Γ_S = Γ_{opt}	1.3	_	dB

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Vs	supply voltage	RF input AC coupled	_	4.5	V
I _S	supply current (DC)	forced by DC voltage on RF input	_	30	mA
P _{tot}	total power dissipation	T _s ≤ 100 °C	_	135	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	operating junction temperature		_	150	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R _{th j-s}	thermal resistance from junction to soldering point	350	K/W

CHARACTERISTICS

RF input AC coupled; T_j = 25 °C; unless otherwise specified.

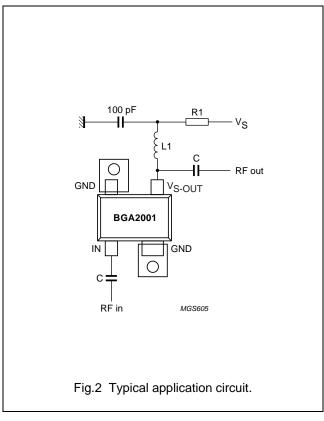
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Is	supply current	V _{VS-OUT} = 1 V	_	0.7	-	mA
		$V_{VS-OUT} = 2.5 V$	3	4.5	6	mA
		$V_{VS-OUT} = 4.5 V$	_	11	_	mA
MSG	maximum stable gain	$V_{VS-OUT} = 2.5 V;$ $I_{VS-OUT} = 4 \text{ mA}; f = 900 \text{ MHz}$	_	22	_	dB
		$V_{VS-OUT} = 2.5 \text{ V};$ $I_{VS-OUT} = 4 \text{ mA}; f = 1.8 \text{ GHz}$	_	19.5	_	dB
$ s_{21} ^2$	insertion power gain	V _{VS-OUT} = 2.5 V; I _{VS-OUT} = 4 mA; f = 900 MHz	_	18	_	dB
		$V_{VS-OUT} = 2.5 V$; $I_{VS-OUT} = 4 \text{ mA}$; $f = 1.8 \text{ GHz}$	_	14	_	dB
PL	load power	at 1 dB gain compression point; $V_{VS-OUT} = 2.5 \text{ V};$ $I_{VS-OUT} = 4.4 \text{ mA}; f = 900 \text{ MHz};$	_	-2	_	dBm
NF	noise figure	$V_{VS-OUT} = 2.5 \text{ V};$ $I_{VS-OUT} = 4 \text{ mA}; \text{ f} = 900 \text{ MHz};$ $\Gamma_S = \Gamma_{\text{opt}}$	_	1.3	-	dB
		$V_{VS-OUT} = 2.5 \text{ V};$ $I_{VS-OUT} = 4 \text{ mA}; \text{ f} = 1.8 \text{ GHz};$ $\Gamma_S = \Gamma_{\text{opt}}$	_	1.3	_	dB
IP3 _(in)	input intercept point; note 1	$V_{VS-OUT} = 2.5 V;$ $I_{VS-OUT} = 4.4 \text{ mA}; f = 900 \text{ MHz}$	_	-7.4	_	dBm
		$V_{VS-OUT} = 2.5 V;$ $I_{VS-OUT} = 4.5 \text{ mA}; f = 1800 \text{ MHz}$	_	-4.5	_	dBm

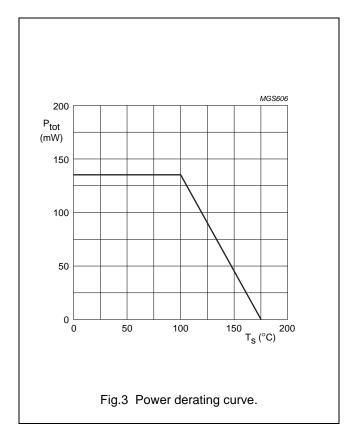
Note

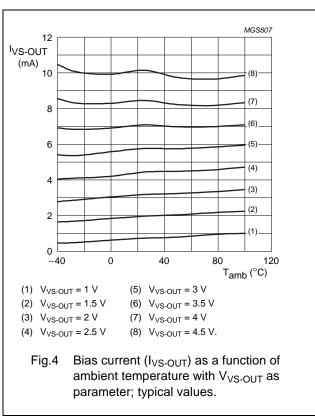
1. See application note: RNR-T45-99-B-0513.

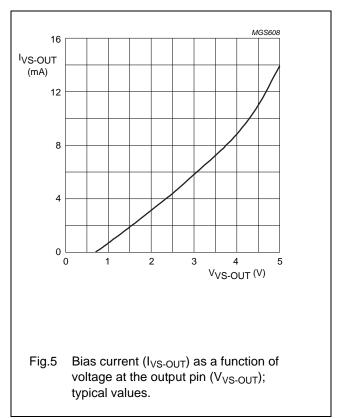
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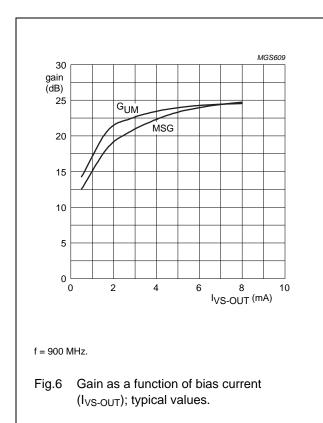


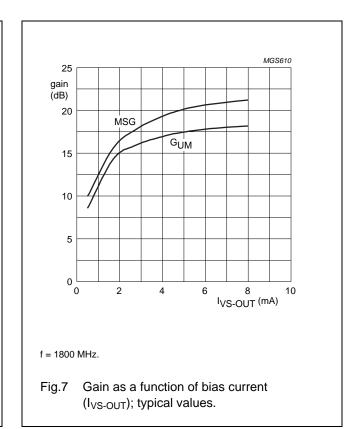


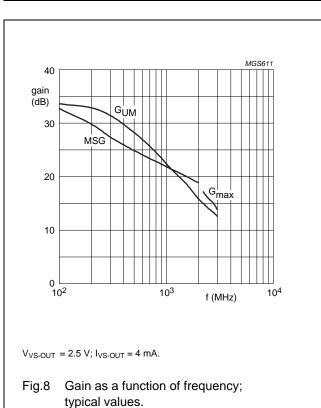


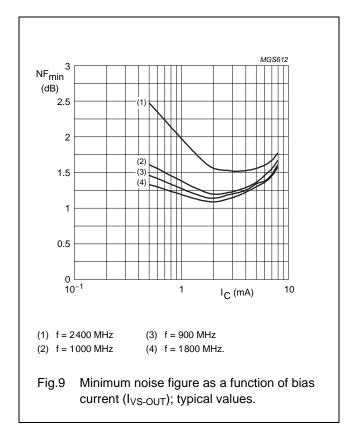
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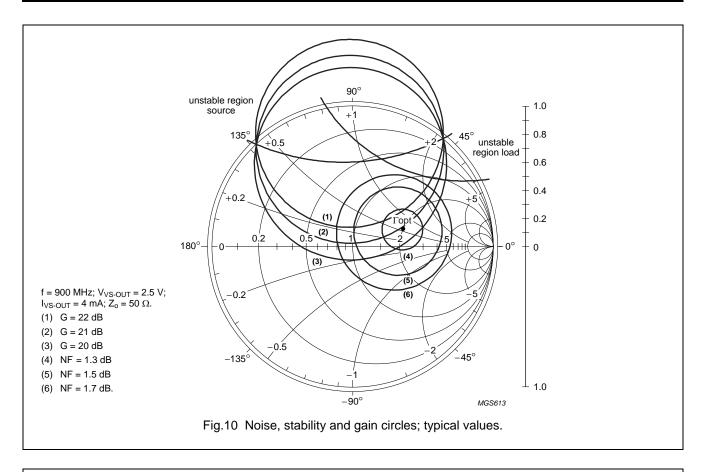


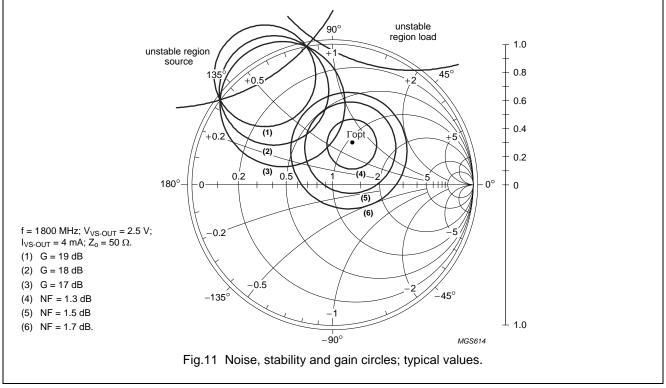


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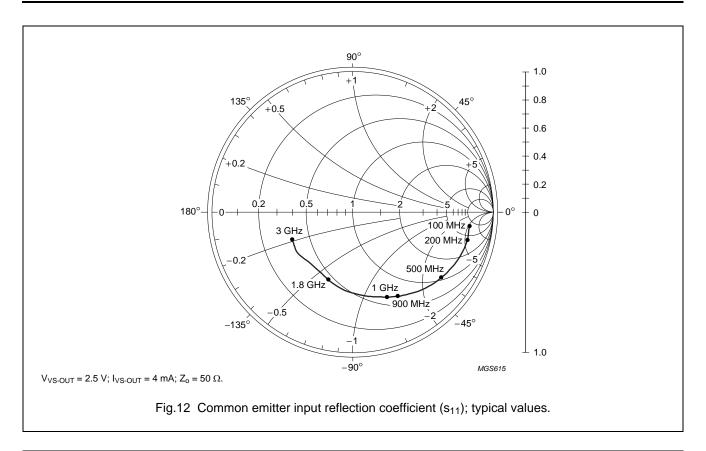


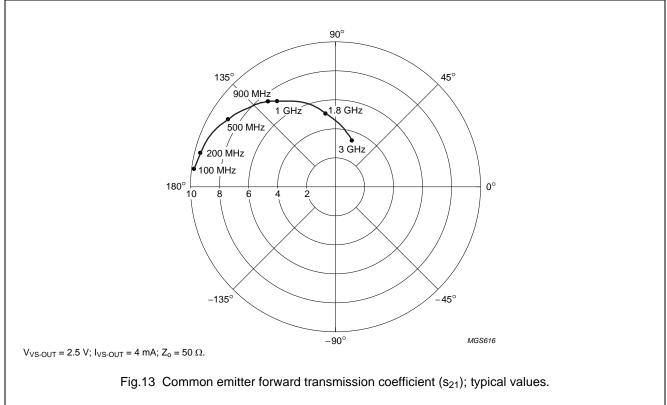


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Silicon MMIC amplifier

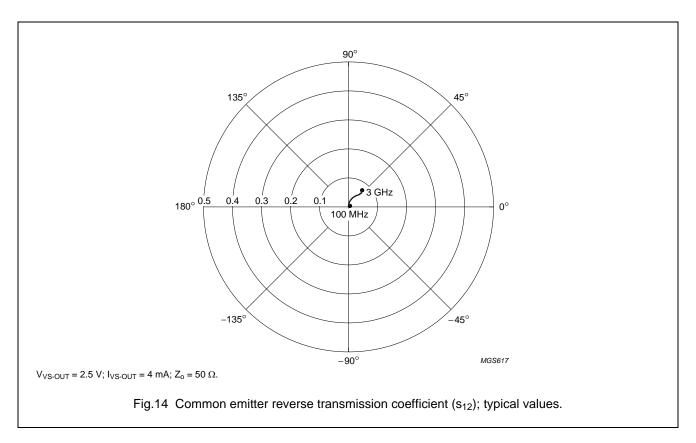
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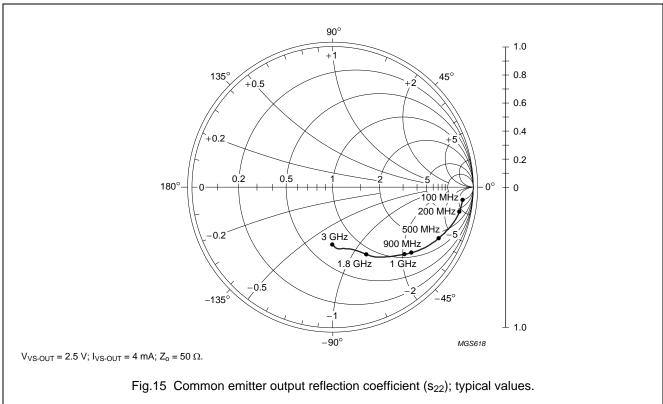




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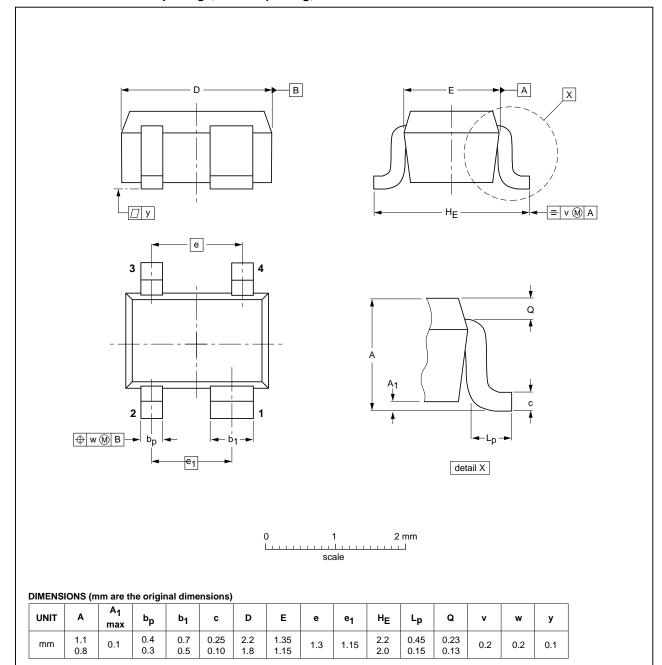
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PACKAGE OUTLINE

Plastic surface-mounted package; reverse pinning; 4 leads

SOT343R



OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT343R						97-05-21 06-03-16

Silicon MMIC amplifier

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DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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